

30V 14A N-Channel MOSFET

Features

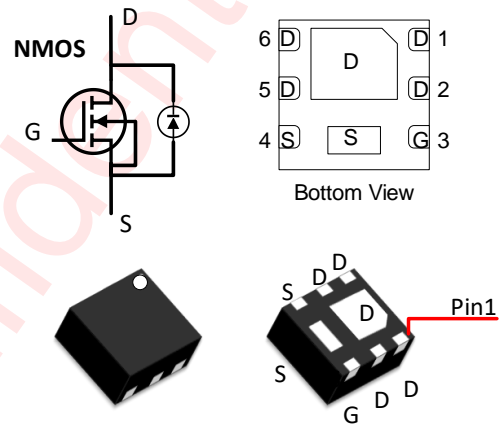
- Advanced trench MOSFET technology
- Ultra-low on-resistance and gate-charge
- RoHS compliant
- 100% UIS tested
- 100% R_g tested
- DFN 2mmX2mmX0.6mm-6L Package

Applications

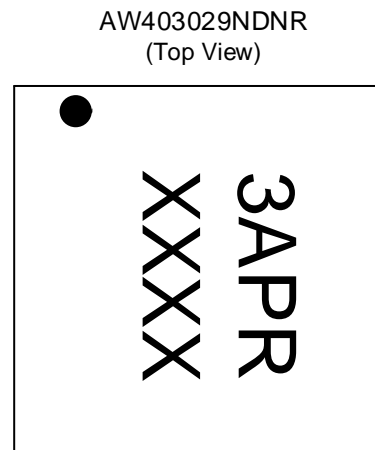
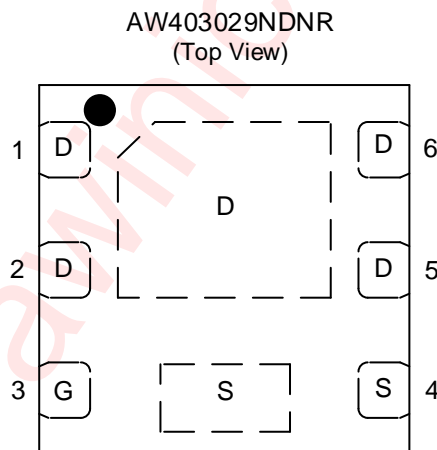
- Motor controllers
- DC-to-DC converters
- Battery-driven electronic products, electrical equipment and machines

General Description

Product Summary	
V _{DS}	30V
R _{DS(ON)}	5.5 mΩ (Typ.)@10V
	7.3 mΩ (Typ.)@4.5V
I _D	14A



Pin Configuration and Top Mark



3APR-AW403029NDNR
XXXX-Production Tracing Code

Ordering Information

Part Number	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW403029NDNR	DFN 2mmX 2mmX0.6mm-6L	3APR	MSL1	RoHS+HF	3000 units/ Tape and Reel

Absolute Maximum Ratings (NOTE 1)

T_A= 25°C unless otherwise noted.

Symbol	Parameter	Maximum	Unit	
V _{DS}	Drain-Source Voltage	30	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D	Drain Current(DC) (NOTE 6)	T _A = 25°C	14	A
		T _A = 100°C	11	A
I _{DM}	Drain Current(Pulse) (NOTE 3)	56	A	
P _D	Power Dissipation (T _A = 25°C)	2.4	W	
T _J	Maximum Operating Junction Temperature	150	°C	
T _{STG}	Storage Temperature	-55 to 150	°C	
I _{AS}	Avalanche Current (NOTE 5)	21	A	
E _{AS}	Avalanche Energy (NOTE 5)	22	mJ	

Thermal Information

Symbol	Parameter	Condition	Value	Unit
R _{θJA}	Maximum Junction to Ambient (NOTE 2, 4)	Steady-State	52	°C/W

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: Mounted on FR-4 material with 1inch², 2oz. Copper.

NOTE3: Test condition 380μs 25°C.

NOTE4: Thermal resistance from junction to ambient is highly dependent on PCB layout.

NOTE5: L= 0.1mH, V_{GS}= 10V, R_g= 25Ω, V_{DS}= 15V.

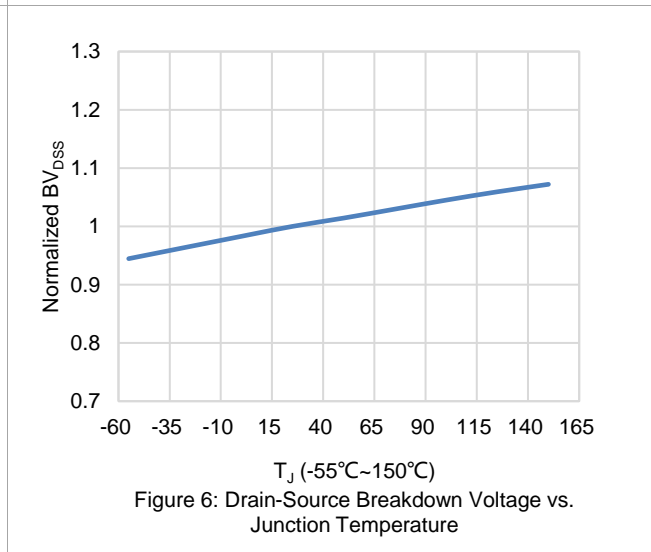
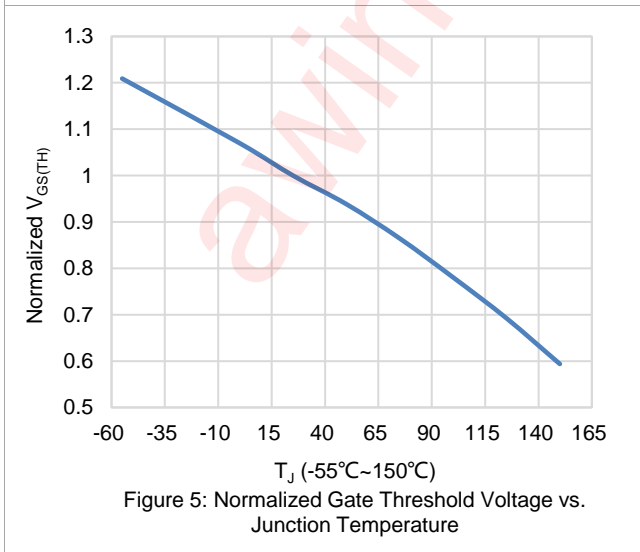
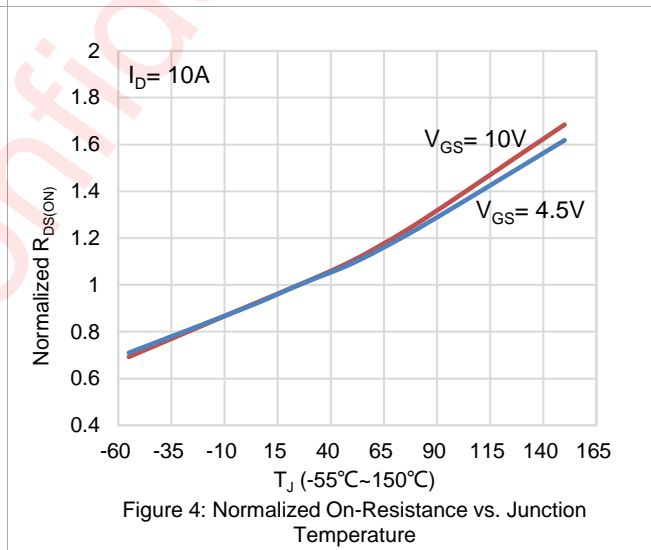
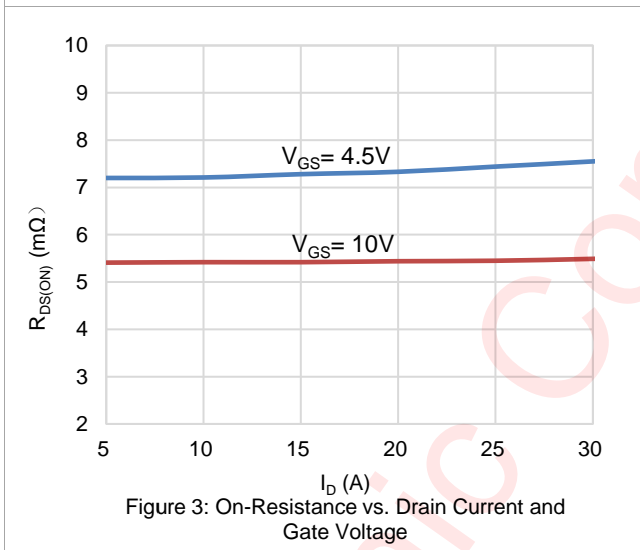
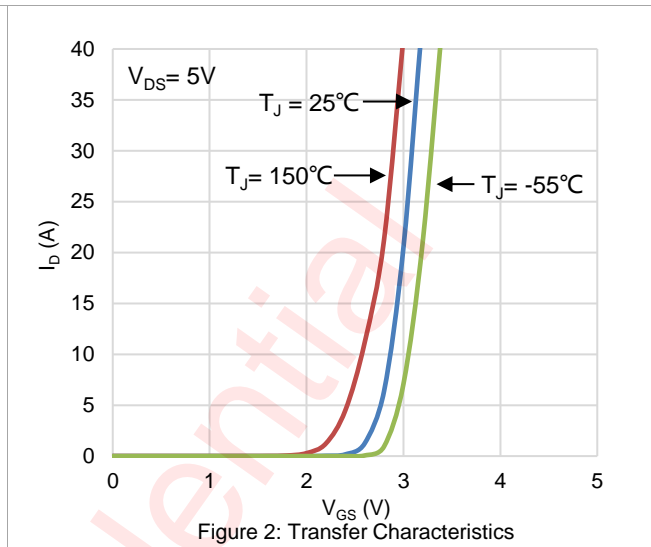
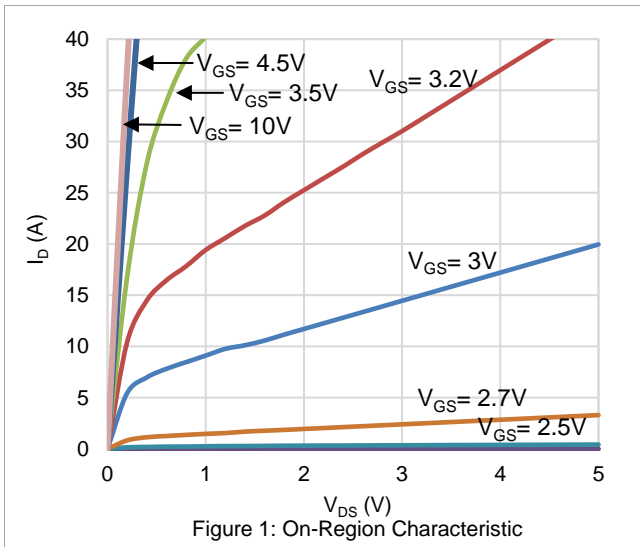
NOTE6: Rated according to R_{θJA}.

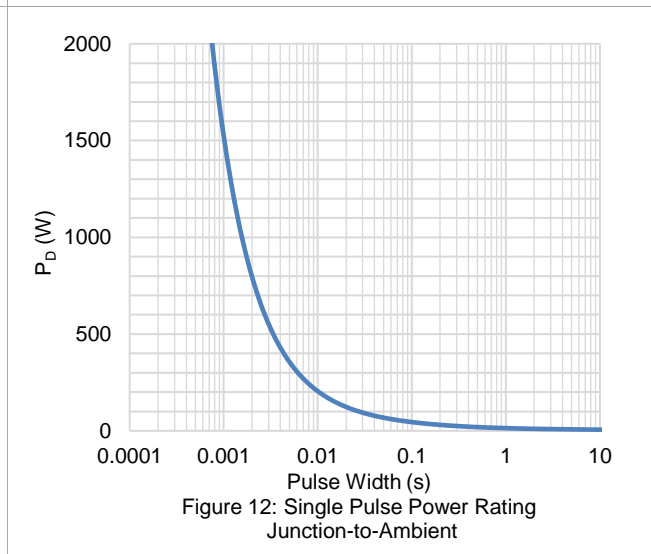
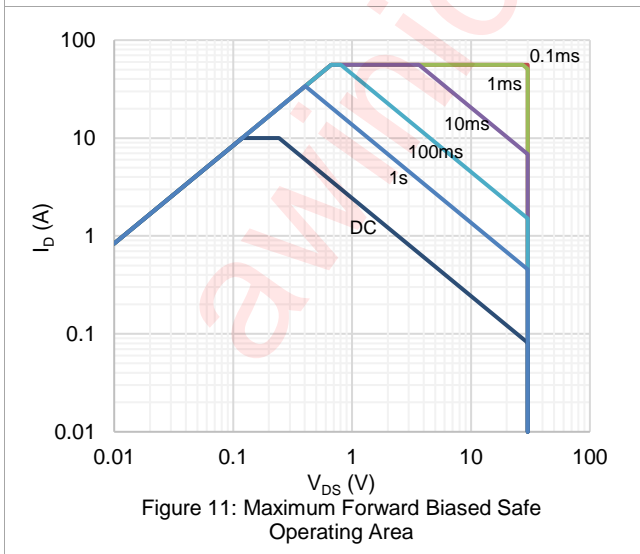
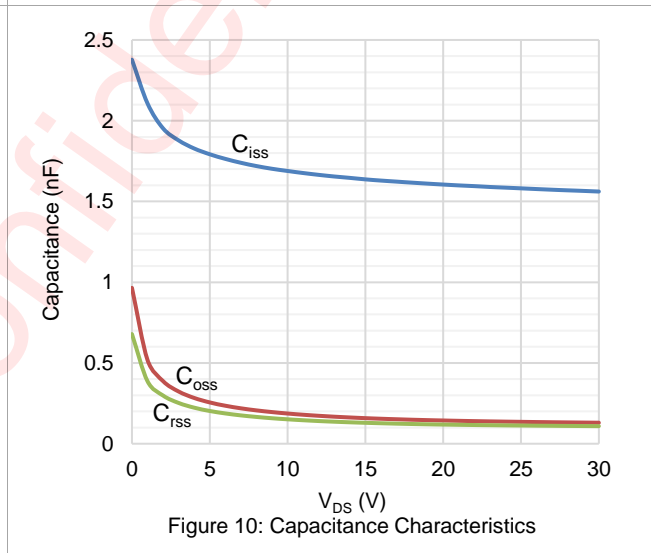
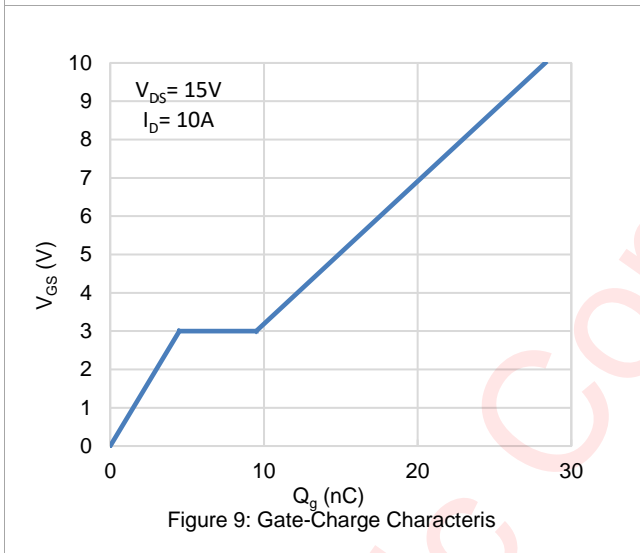
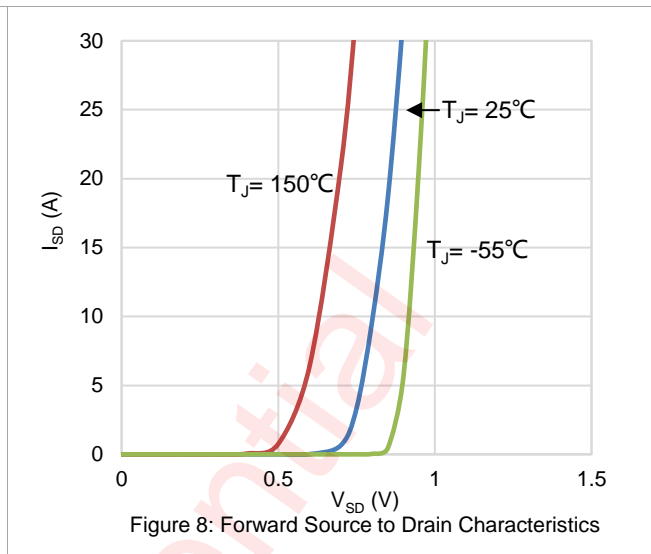
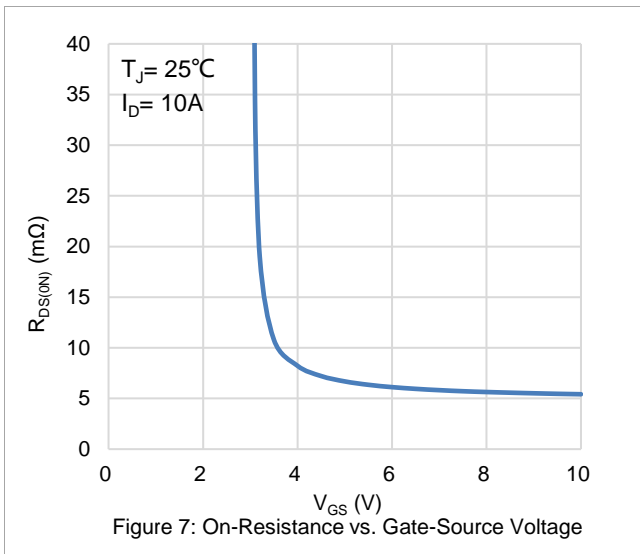
Electrical Characteristics

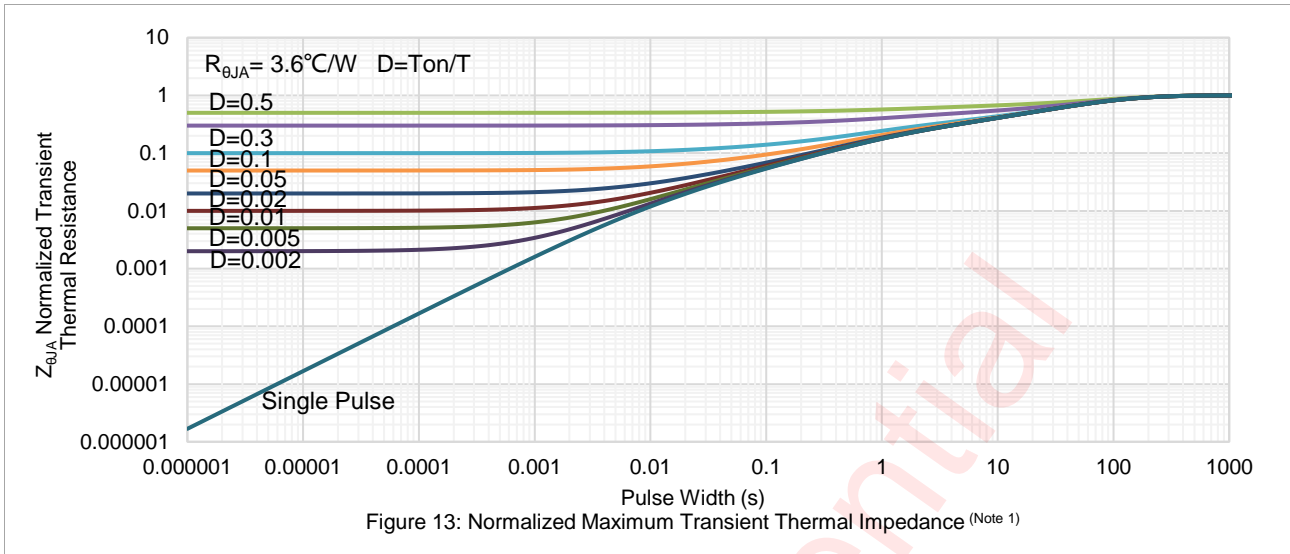
T_J= 25°C for typical values (unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
B _V DSS	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	1.2	-	2.4	V
R _{DS(ON)}	Static Drain to Source On-Resistance	V _{GS} = 10V, I _D = 10A	-	5.5	7	mΩ
		V _{GS} = 4.5V, I _D = 10A	-	7.3	9.0	mΩ
g _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 10A	-	65	-	S
V _{SD}	Diode Forward Voltage	I _S = 1A, V _{GS} = 0V	-	0.7	-	V
DYNAMIC PARAMETERS						
R _g	Gate Resistance	f= 1MHz	-	2	-	Ω
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 15V, f= 1MHz	-	1530	-	pF
C _{oss}	Output Capacitance		-	150	-	pF
C _{rss}	Reverse Transfer Capacitance		-	120	-	pF
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} = 10V, V _{DS} = 15V, I _D = 10A	-	28	-	nC
Q _{gs}	Gate Source Charge		-	4.5	-	nC
Q _{gd}	Gate Drain Charge		-	5	-	nC
t _{d(on)}	Turn-On Delay Time	V _{DS} = 15V, I _D = 10A, R _g = 3Ω, V _{GS} = 10V	-	6.5	-	ns
t _r	Turn-On Rise Time		-	3	-	ns
t _{d(off)}	Turn-Off Delay Time		-	25	-	ns
t _f	Turn-Off Fall Time		-	12	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _D = 10A, di/dt= 100A/μs	-	13.5	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _D = 10A, di/dt= 100A/μs	-	5.3	-	nC

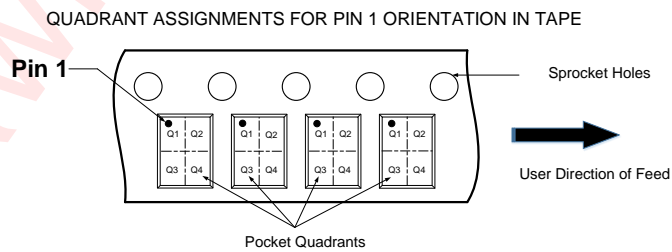
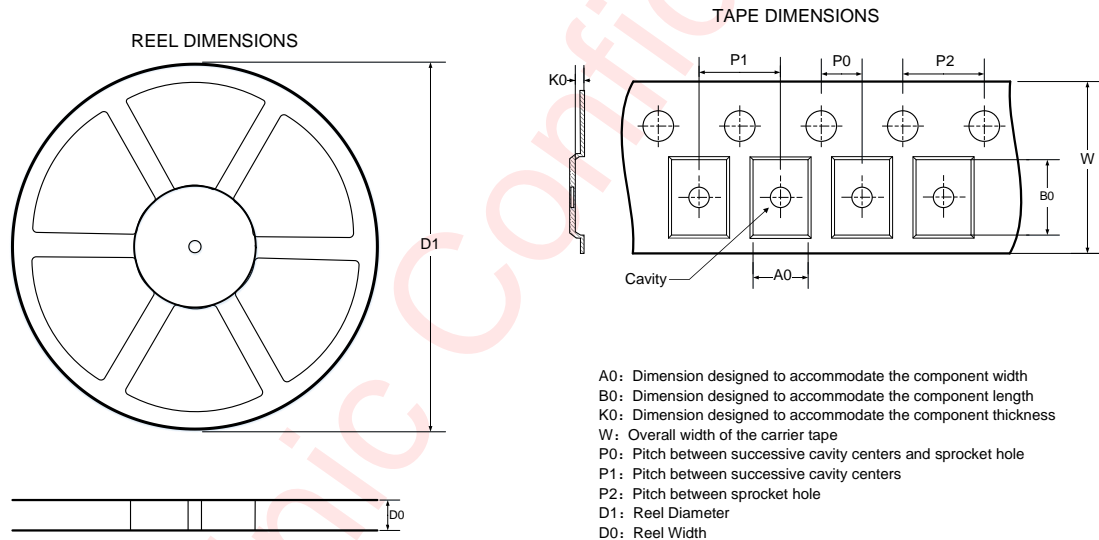
Typical Electrical and Thermal Characteristics







Tape And Reel Information

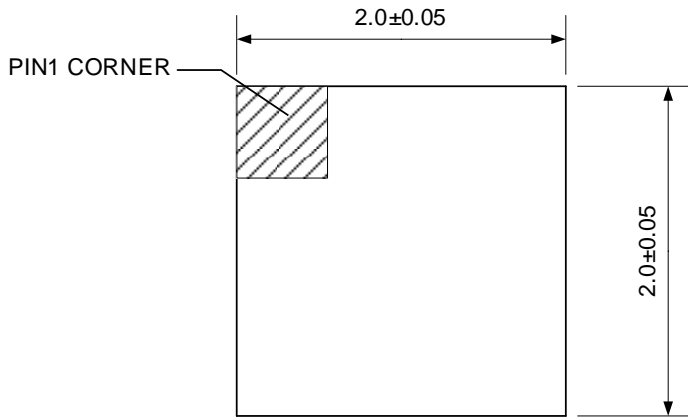


Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

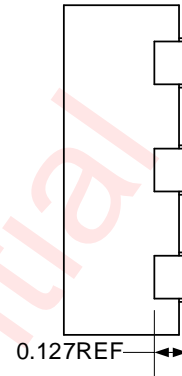
DIMENSIONS AND PIN1 ORIENTATION									
D1 (mm)	D0 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
178	8.4	2.25	2.25	0.75	2	4	4	8	Q1

All dimensions are nominal

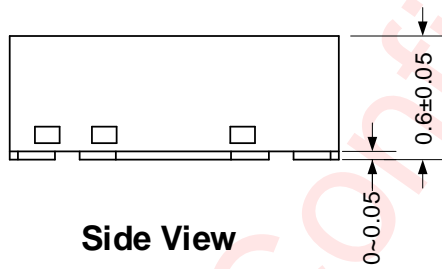
Package Description



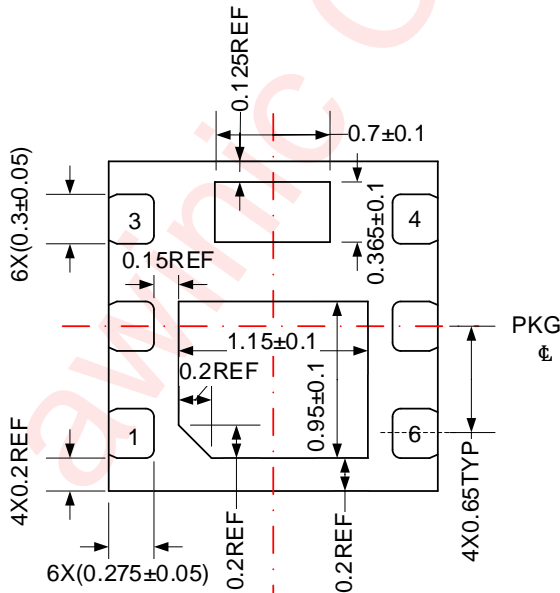
Top View



Side View



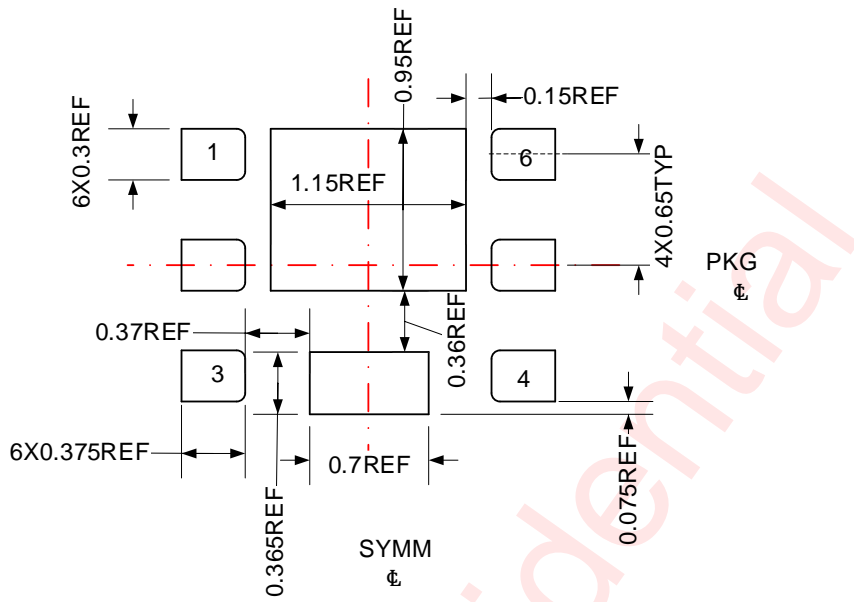
Side View



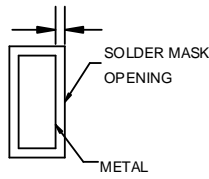
Bottom View

Unit: mm

Land Pattern Data

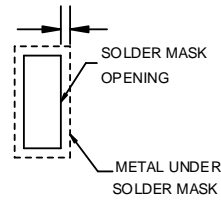


0.05 MAX
All AROUND



NON SOLDER MASK DEFINED

0.05 MIN
All AROUND



SOLDER MASK DEFINED

Unit: mm

Revision History

Version	Date	Change Record
V1.0	Nov. 2022	Official released

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